



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Assistant Commissioner of Patents  
BOX Non-Fee Amendment  
Washington, D.C. 20231

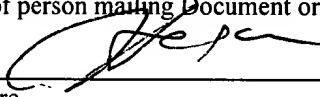


2812  
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I hereby certify that this correspondence is being deposited  
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Harold C. Moore

Name of person mailing Document or Fee

  
Signature

February 18, 2003

Date of Signature

Re:	Application of:	Newell E. Chiesl
	Serial No.:	09/960,441
	Filed:	September 21, 2001
	For:	Arrangement for Measuring Pressure on a Semiconductor Wafer and an Associated Method for Fabricating a Semiconductor Wafer
	Group Art Unit:	2812
	Examiner:	Viktor Simkovic
	Our Docket No.:	1003-0610

TRANSMITTAL OF RESPONSE TO OFFICE ACTION

Please find for filing in connection with the above patent application the  
following:

1. Response to Office Action.

\* The fee has been calculated as shown below.

CLAIMS AS AMENDED				
	Claims Remaining After Amendment	Highest No. Paid For	Fee Calculation	Addit Fee
Total Claims	11	20	0 X 9	\$ 0.00
Independent Claims	2	3	0 X 42	\$ 0.00
Total Additional Fee Required				\$ 0.00

Please charge any fee deficiency, or credit any overpayment, to Deposit Account No. 13-0014; but not to include any payment of issue fees.

Respectfully Submitted,

MAGINOT, MOORE & BOWMAN



February 18, 2003

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Enclosures